PCN Nur		mber:	202	002100		PCN Date:	Feb. 17, 2020					
Title: Datash		Datasheet fo	et for BQ33100									
Customer Contact:			<u>PCN</u>	Manag	<u>er</u>			Dept:			Quality Services	
Ch	ange	Туре:										
	Asse	Assembly Site				Design				Wafer	Bump Site	
	Assembly Process			\boxtimes	Data Sheet				Wafer Bump Material			
	Assembly Materials			Part num		Part numb	per change			Wafer Bump Process		
	Mechanical Specificatio			Test Site			Wafer Fa					
Packing/Shipping/L			_abeling			Test Process				Wafer Fab Materials		
	Wafer Fab Proc										Fab Process	
Notification Details												
Description of Change:												
Texas Instruments Incorporated is announcing an information only notification.												
The product datasheet(s) is being updated as summarized below.												
The following change history provides further details.												
	j Ţex	AS									BQ33100	
INSTRUMENTS SLUS987C – JANUARY 2011–REVISED DECEMBER 2019												
Changes from Revision B (December 2015) to Revision C Page												
	Change	d Recommended	Operat	ing Condi	ition	s					6	
•	Changed OC Dsg											
	Changed OC Dsg Time											
	Changed SC Dsg Cfg											
Changed Initial 1st Capacitance												
Changed Capacitance												
	Changed Measurement Margin %											
•	Changed Max Dsg Time										51	
•	Changed V Chg Nominal									51		
•										51		
•	Change	d V Chg B									51	
•	Changed V Chg Max										51	
•	Change	d Min Voltage									51	
•	Change	d Learning Freque	ency									
The	e data	sheet number	will b	e chang	gin	g.						
D	evice	Family				Cha	inge From:			Change	e To:	
В	BQ33100				SLU	IS987B			SLUS98	37C		
These changes may be reviewed at the datasheet links provided.												
		5 /										
http://www.ti.com/product/BQ33100												
		for Change: ately reflect de		ah a va at								
		,										
		-				-	-				tive / negative):	
No anticipated impact. This is a specification change announcement only. There are no changes to the actual device.												
Changes to product identification resulting from this PCN:												
None.												
Product Affected:												
	Q331			3Q3310		WR						
	اددى			142210	UP	VV IN						

For questions regarding this notice, e-mails can be sent to the regional contacts shown below, or you can contact your local Field Sales Representative.

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